

X REGULAR (UTILITY) OR DESIGN APPLICATION (check one)

			rney Docket CE0805	1R
As a below-named inventor, I	hereby declare that:			
My residence, post office add	ress and citizenship ar	e as stated below next to m	y name.	
I believe I am the original, firs joint inventor (if plural names is sought on the invention ent the specification of which:	are listed below) of the	subject matter which is cla	med and for w	l, first and hich a patent
	_X is attached	d hereto.		
(check one)	was filed o U.S. Appli and was a	cation Serial No.	as le)	
I hereby state that I have revi including the claims, as amen			entinea specino	cation,
I acknowledge the duty to disaccordance with Title 37, Coo	close information whicl le of Federal Regulatio	n is material to the examinations, Section 1.56(a).	ion of this appl	ication in
I hereby claim foreign priority application(s) for patent or inva application for patent or inver priority is claimed:	entor's certificate lister	d below and have also ident	ified below any	foreign
Prior Foreign Application(s):				
(check one)	X no such application	cations filed.		Priority <u>Claimed</u>
(Serial No.)	(Country)	(Day/Month/Year Filed)	Yes	No
(Serial No.)	(Country)	(Day/Month/Year Filed)	Yes	No
(Serial No.)	(Country)	(Day/Month/Year Filed)	Yes	No
,		,		
I hereby claim the priority ben	rent under Hitle 35. UNI	ieu states code, section 12	o or any united	u States

I hereby claim the priority benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56(a) which is material to the examination of this application and which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Applications(s):					
(check one)	X no such applications filed.such applications identified as follows:				
(Application Serial No.)	(Filing Date)	(Status) (Patented, Pending, Abandoned)			
(Application Serial No.)	(Filing Date)	(Status) (Patented, Pending, Abandoned)			
(Application Serial No.)	(Filing Date)	(Status) (Patented Pending Abandoned)			

I hereby declare that: as to any claimed subject matter of this application which is common to my earlier United States or foreign application(s), if any, which I have identified above and claimed the benefit of priority thereof, I do not believe that the same was ever known or used in the United States before my invention thereof or patented or described in any printed publication in any country before my invention thereof or more than one year prior to the first of said earlier application(s), or in public use or on sale in the United States more than one year prior to the first of said earlier application(s), and that the said common subject matter has not been patented or made the subject of an inventor's certificate before the date of the first of said earlier U.S. application(s) in any country foreign to the United States on an application, filed by me or my legal representatives or assigns more than twelve months (six months if the present application is a Design patent application) prior to the first of said earlier U.S. application(s), if any; and that, as to any claimed subject matter of this application which is not common to said earlier application(s), if any, I do not know and do not believe that the same was ever known or used in the United States before my invention thereof or patented or described in any printed publication in any country before my invention thereof or more than one year prior to the date of this application, or in public use or on sale in the United States more than one year prior to the date of this application, and that said subject matter has not been patented or made the subject of an inventor's certificate in any country foreign to the United States on an application filed by me or my legal representatives or assigns more than twelve months (six months if the present application is a Design patent application) prior to the date of this application.

I HEREBY APPOINT THE FOLLOWING AS MY ATTORNEY(S) OR AGENT(S) WITH FULL POWER OF SUBSTITUTION TO PROSECUTE THIS APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH:

REGISTRATION ASSOCIATE POWER O	-
NO.(S) ATTORNEY ATTACHE	
30,477	
28,790	
36,062	
29,420	
34,043	
36,283	
39,157	
42,614	
42,311	
X	
Yes No	
36,062 29,420 34,043 36,283 39,157 42,614 42,311	

Send Written Correspondence To: Intellectual Property Section – Law Department MOTOROLA, INC. 1303 East Algonquin Road Schaumburg, IL 60196 Direct Telephone Calls to: (847) 576-0379

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statement and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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